

October 2015

# **KSD5041 NPN Epitaxial Silicon Transistor**

#### **Features**

- · AF Output Amplifier for Electronic Flash Unit
- · Low Collector-Emitter Saturation Voltage
- · High Performance at Low Supply Voltage



### **Ordering Information**

Part Number	Top Mark	Package	Packing Method
KSD5041RTA	D5041	TO-92 3L	Ammo
KSD5041QTA	D5041	TO-92 3L	Ammo

#### **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at  $T_A = 25$ °C unless otherwise noted.

Symbol	Parameter	Value	Unit
V <sub>CBO</sub>	Collector-Base Voltage	40	V
V <sub>CEO</sub>	Collector-Emitter Voltage	20	V
V <sub>EBO</sub>	Emitter-Base Voltage	7	V
I <sub>C</sub>	Collector Current	5	Α
T <sub>J</sub> Junction Temperature		150	°C
T <sub>STG</sub>	Storage Temperature	-55 to 150	°C

## Thermal Characteristics(1)

Values are at  $T_A = 25$ °C unless otherwise noted.

Symbol	Parameter	Value	Unit
В	Power Dissipation	0.75	W
P <sub>D</sub>	Derate Above 25°C	6.0	mW/°C
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	166.6	°C/W

#### Note:

1. PCB size: FR-4, 76 mm x 114 mm x 1.57 mm (3.0 inch x 4.5 inch x 0.062 inch) with minimum land pattern size.

#### **Electrical Characteristics**

Values are at  $T_A = 25$ °C unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>CEO</sub>	Collector-Emitter Breakdown Voltage	$I_C = 1 \text{ mA}, I_B = 0$	20			V
BV <sub>EBO</sub>	Emitter-Base Breakdown Voltage	$I_E = 10 \mu A, I_C = 0$	7			V
I <sub>CBO</sub>	Collector Cut-Off Current	$V_{CB} = 10 \text{ V}, I_{E} = 0$			0.1	μΑ
I <sub>EBO</sub>	Emitter Cut-Off Current	$V_{EB} = 7 \text{ V}, I_{C} = 0$			0.1	μΑ
h <sub>FE1</sub>	DC Current Gain	$V_{CE} = 2 \text{ V}, I_{C} = 0.5 \text{ A}$	180		600	
h <sub>FE2</sub>	DO Current Cam	$V_{CE} = 2 \text{ V}, I_{C} = 2 \text{ A}$	150			
V <sub>CE</sub> (sat)	Collector-Emitter Saturation Voltage	$I_C = 3 A, I_B = 0.1 A$			1	V
f <sub>T</sub>	Current Gain Bandwidth Product	$V_{CE} = 6 \text{ V}, I_{C} = 50 \text{ mA}$		150		MHz
C <sub>ob</sub>	Output Capacitance	$V_{CB} = 20 \text{ V}, I_{E} = 0,$ f = 1 MHz			50	pF

# h<sub>FE</sub> Classification

Classification	Р	0	R
h <sub>FF1</sub>	180 ~ 270	230 ~ 380	340 ~ 600

# **Typical Performance Characteristics**

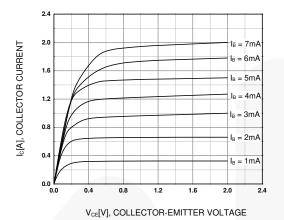


Figure 1. Static Characteristic

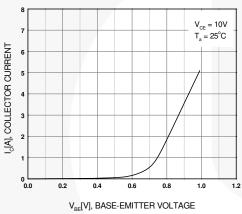
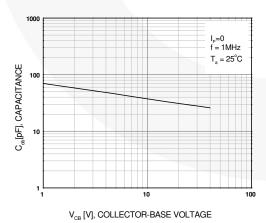


Figure 3. Base-Emitter Saturation Voltage



**Figure 5. Collector Output Capacitance** 

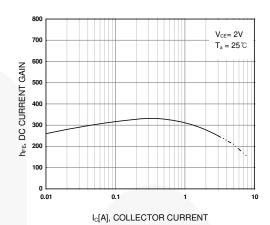


Figure 2. DC Current Gain

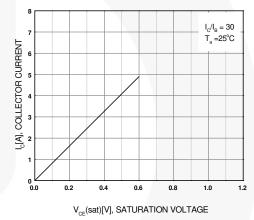


Figure 4. Collector-Emitter Saturation Voltage

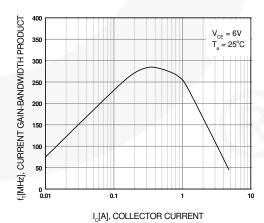


Figure 6. Current Gain Bandwidth Product

# **Typical Performance Characteristics** (Continued)

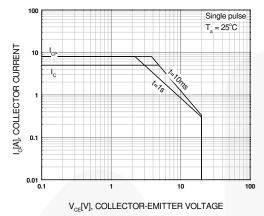


Figure 7. Safe Operating Area

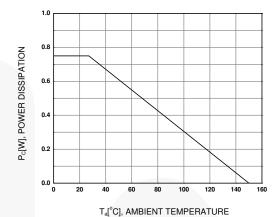
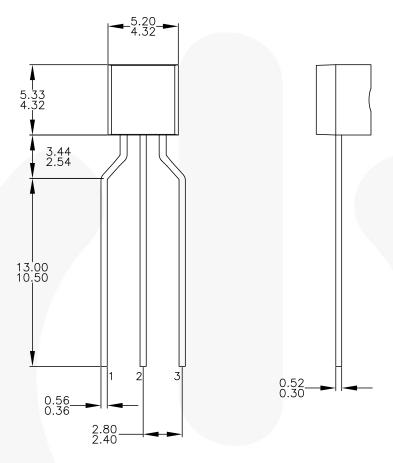
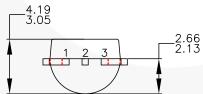


Figure 8. Power Derating

# **Physical Dimensions**





NOTES: UNLESS OTHERWISE SPECIFIED

- DRAWING CONFORMS TO JEDEC MS-013, VARIATION AC. ALL DIMENSIONS ARE IN MILLIMETERS. DRAWING CONFORMS TO ASME Y14.5M-2009. DRAWING FILENAME: MKT-ZAO3FREV3. FAIRCHILD SEMICONDUCTOR.

Figure 9. 3-Lead, TO-92, Molded, 0.2 In Line Spacing Lead Form, Ammo Type





#### TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

AccuPower™ F-PFS™ AttitudeEngine™ FRFET<sup>®</sup> Awinda® AX-CAP®\* Global Power Resource SM GreenBridge™

BitSiC™ Green FPS™ Build it Now™ Green FPS™ e-Series™

CorePLUS™ Gmax™ GTO™ CorePOWER™  $CROSSVOLT^{\text{\tiny TM}}$ IntelliMAX™  $\mathsf{CTL}^\mathsf{TM}$ ISOPI ANAR™

Current Transfer Logic™ Making Small Speakers Sound Louder **DEUXPEED**® and Better™

Dual Cool™ MegaBuck™ EcoSPARK® MICROCOUPLER™ EfficientMax™ MicroFET™ MicroPak™ ESBC™ MicroPak2™

MillerDrive™ Fairchild® MotionMax™ Fairchild Semiconductor® MotionGrid® FACT Quiet Series™ MTi<sup>®</sup> FACT MTx® FastvCore™ MVN® FFTBench™ mWSaver®

**FPS™** OptoHiT™ OPTOLOGIC® OPTOPLANAR®

Power Supply WebDesigner™

PowerTrench PowerXS™

Programmable Active Droop™

QFĔT QS™ Quiet Series™ RapidConfigure™

Saving our world, 1mW/W/kW at a time™

SignalWise™ SmartMax™ SMART START™

Solutions for Your Success™

SPM<sup>®</sup> STEALTH™ SuperFET® SuperSOT™-3 SuperSOT™-6 SuperSOT™-8 SupreMOS<sup>®</sup> SyncFET™

Sync-Lock™

UniFET™ VCX™ XSTM Xsens™

SYSTEM GENERAL®\* TinyBoost® TinyBuck<sup>®</sup> TinyCalc™ TinyLogic<sup>®</sup> TINYOPTO™ TinyPower™ TinyPWM™ TinvWire™ TranSiC™ TriFault Detect™ TRUECURRENT®\*

UHC<sup>®</sup> Ultra FRFET™ VisualMax™ VoltagePlus™ 仙童®

μSerDes™

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. TO OBTAIN THE LATEST, MOST UP-TO-DATE DATASHEET AND PRODUCT INFORMATION, VISIT OUR <u>AIRCHILDSEMI.COM.</u> FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN. WHICH COVERS THESE PRODUCTS.

#### **AUTHORIZED USE**

Unless otherwise specified in this data sheet, this product is a standard commercial product and is not intended for use in applications that require extraordinary levels of quality and reliability. This product may not be used in the following applications, unless specifically approved in writing by a Fairchild officer: (1) automotive or other transportation, (2) military/aerospace, (3) any safety critical application - including life critical medical equipment - where the failure of the Fairchild product reasonably would be expected to result in personal injury, death or property damage. Customer's use of this product is subject to agreement of this Authorized Use policy. In the event of an unauthorized use of Fairchild's product, Fairchild accepts no liability in the event of product failure. In other respects, this product shall be subject to Fairchild's Worldwide Terms and Conditions of Sale, unless a separate agreement has been signed by both Parties.

#### ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com,

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors

#### PRODUCT STATUS DEFINITIONS

Definition of Terms				
<b>Datasheet Identification</b>	Product Status	Definition		
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.		
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.		
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.		
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.		

Rev. 177

<sup>\*</sup> Trademarks of System General Corporation, used under license by Fairchild Semiconductor.